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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. XIE, et al.

Serial No.: 09/964,494

Filed: September 28, 2001

For: ARRANGEMENTS TO INCREASE STRUCTURAL RIGIDITY OF SEMICONDUCTOR PACKAGE

Group: 2826

Examiner: A. Williams

AMENDMENT

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

June 20, 2003

Sir:

In response to the Office Action dated June 5, 2003, please amend the above-identified application as follows:

IN THE TITLE:

✓ Please change the title to --HEAT SPREADER AND STIFFENER HAVING A STIFFENER EXTENSION--.

IN THE SPECIFICATION:

Please replace the paragraph beginning on page 5, line 7 with the following rewritten paragraph:

--The IHS/IS may also be adapted to have an electrical function. Reference is made to U.S. Patent Application No. 09/964,586 entitled "Arrangements to Supply

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JUN 23 2003

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